



MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

Table 1 Parameter

R_{DS(on),max}

Q_G (0V..10V)

 $V_{\rm DS}$

 I_{D}

Qoss

Qsw

- N-channel, normal level

Key Performance Parameters

Unit

V

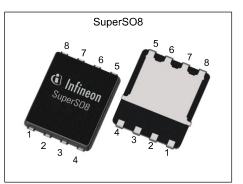
A

nC

nC

nC

mΩ



Drain Gate Pin 4 Source Pin 1-3 *1: Internal body diode





| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|---------------|
| BSC110N15NS5 | PG-TDSON-8 | 110N15NS | - |

Excellent gate charge x R_{DS(on)} product (FOM) Very low on-resistance R_{DS(on)} 150 °C operating temperature Pb-free lead plating; RoHS compliant Qualified according to JEDEC¹⁾ for target application Ideal for high-frequency switching and synchronous rectification

Value

150

11

76

78

28

11.5

¹⁾ J-STD20 and JESD22 **Final Data Sheet**



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

| Demonstern | Oh. a l | | Values | | | | |
|--|-----------------------------------|------|--------|----------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Continuous drain current | I _D | - | - | 76 48 | A | <i>T</i> _C =25 °C <i>T</i> _C =100 °C | |
| Pulsed drain current ¹⁾ | I _{D,pulse} | - | - | 304 | A | <i>T</i> _c =25 °C | |
| Avalanche energy, single pulse ²⁾ | EAS | - | - | 100 | mJ | I _D =50 A, R _{GS} =25 Ω | |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - | |
| Power dissipation | Ptot | - | - | 125 | W | <i>T</i> _c =25 °C | |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 150 | °C | IEC climatic category; DIN IEC 68-1: 55/150/56 | |

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

| Demonster | Complete L | Values | | | 11 | |
|---|-------------------|--------|------|------|------|-----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | 0.6 | 1 | K/W | - |
| , 6 cm ² cooling area ³⁾ | R _{thJA} | - | - | 50 | K/W | - |

Electrical characteristics 3

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

| Devenuestan | Course had | | Values | | | | |
|----------------------------------|----------------------|------|-----------|------------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 150 | - | - | V | V _{GS} =0 V, <i>I</i> _D =1 mA | |
| Gate threshold voltage | V _{GS(th)} | 3 | 3.8 | 4.6 | V | V _{DS} =V _{GS} , <i>I</i> _D =91 μA | |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μA | V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C | |
| Gate-source leakage current | I _{GSS} | - | 1 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 9 10 | 11 12.7 | mΩ | V _{GS} =10 V, <i>I</i> _D =38 A, V _{GS} =8 V, <i>I</i> _D =19 A, | |
| Gate resistance ⁴⁾ | R _G | - | 0.9 | 1.35 | Ω | - | |
| Transconductance | g fs | 29 | 58 | - | S | V _{DS} >2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =38 A | |

¹⁾ See Diagram 3 for more detailed information
 ²⁾ See Diagram 13 for more detailed information
 ³⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection.

PCB is vertical in still air. ⁴⁾ Defined by design. Not subject to production test

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Table 5 **Dynamic characteristics**

| Parameter | Symbol | Values | | | 11 | |
|--|--------------------|--------|------|------|------|--|
| | | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | Ciss | - | 2080 | 2770 | pF | V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz |
| Output capacitance ¹⁾ | Coss | - | 515 | 685 | pF | V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance ¹⁾ | C _{rss} | - | 13 | 23 | pF | V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz |
| Turn-on delay time | t _{d(on)} | - | 10.3 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω |
| Rise time | t _r | - | 3.3 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω |
| Turn-off delay time | $t_{\rm d(off)}$ | - | 14.5 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω |
| Fall time | t _f | - | 2.9 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 Ω |

Gate charge characteristics²⁾ Table 6

| Parameter | Symbol | Values | | | llmit | Note / Toot Condition |
|------------------------------------|------------------|--------|------|------|-------|--|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 12 | - | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge ¹⁾ | $Q_{ m gd}$ | - | 5.8 | 9 | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge | Q _{sw} | - | 11.5 | - | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total ¹⁾ | Qg | - | 28 | 35 | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage | $V_{ m plateau}$ | - | 5.8 | - | V | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V |
| Output charge ¹⁾ | Q _{oss} | - | 78 | 103 | nC | V _{DD} =75 V, V _{GS} =0 V |

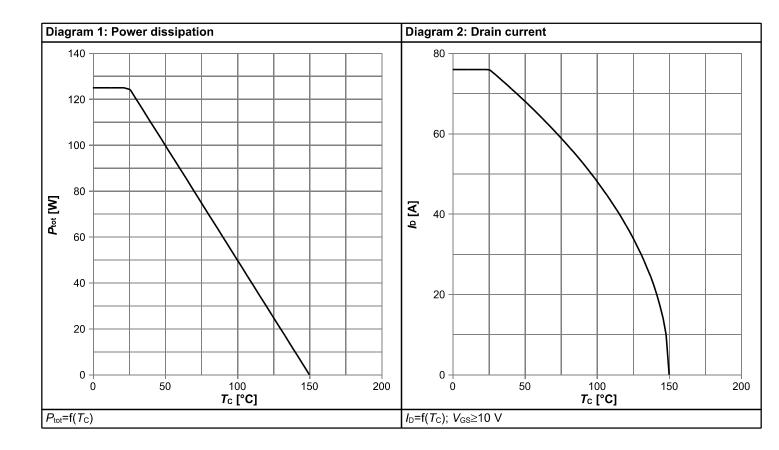
Reverse diode Table 7

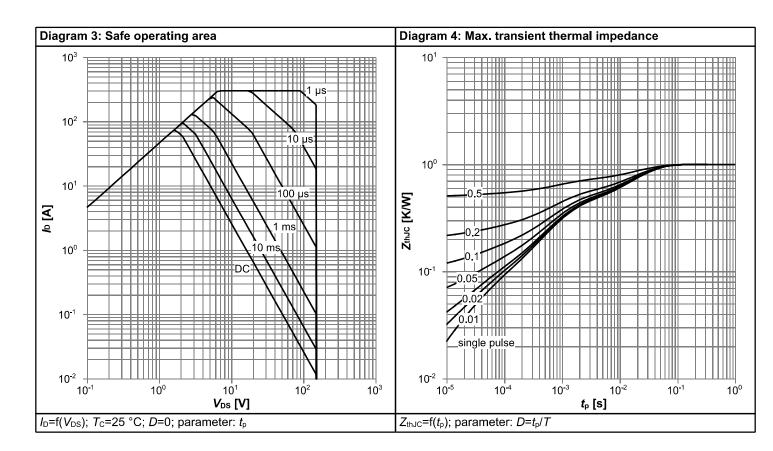
| Parameter | C. maked | | Values | | | |
|---------------------------------------|----------------------|------|--------|------|------|--|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continous forward current | l _s | - | - | 86 | A | <i>T</i> _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 304 | A | <i>T</i> _C =25 °C |
| Diode forward voltage | V _{SD} | - | 0.88 | 1.2 | V | V _{GS} =0 V, <i>I</i> _F =38 A, <i>T</i> _j =25 °C |
| Reverse recovery time ¹⁾ | t _{rr} | - | 45 | 90 | ns | V _R =75 V, <i>I</i> _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/µs |
| Reverse recovery charge ¹⁾ | Q _{rr} | - | 46 | 92 | nC | V _R =75 V, <i>I</i> _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/µs |

 $^{1)}$ Defined by design. Not subject to production test $^{2)}$ See "Gate charge waveforms" for parameter definition

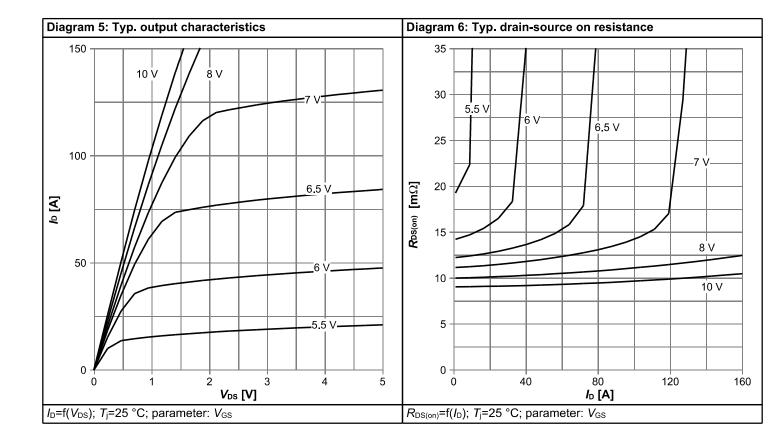


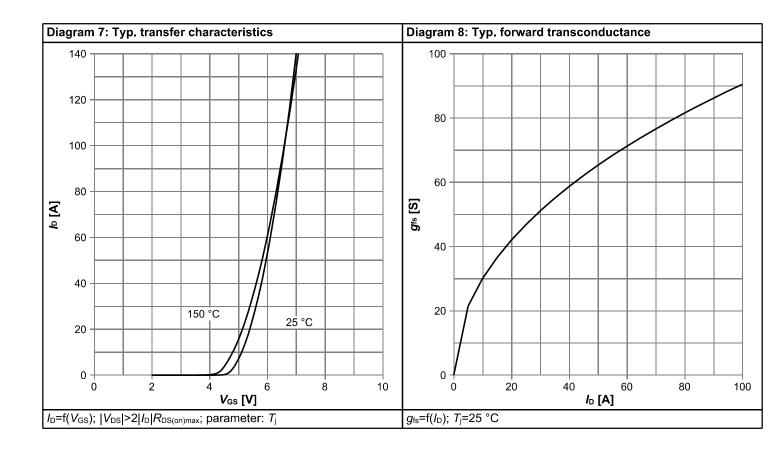
4 Electrical characteristics diagrams



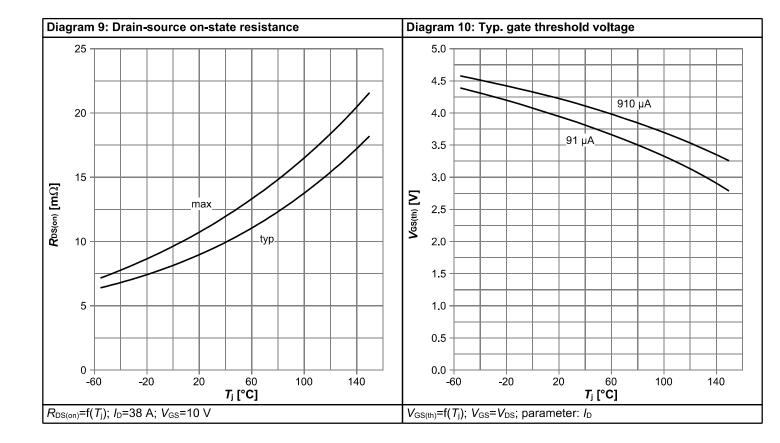


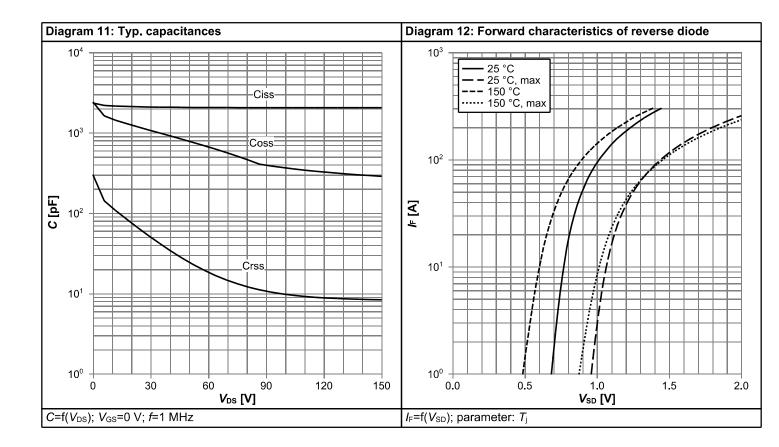




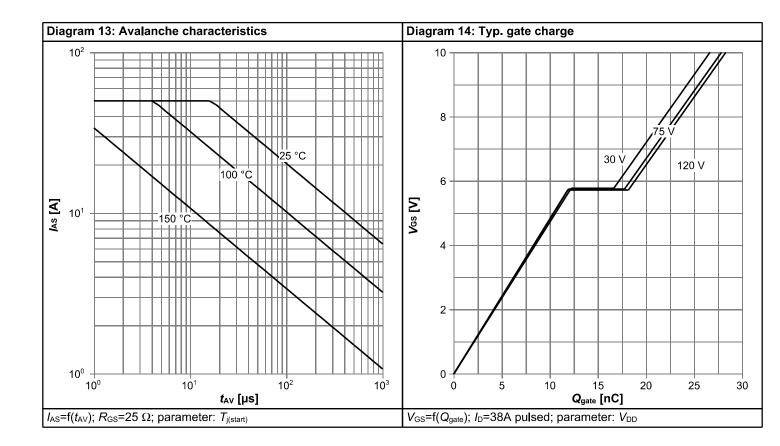


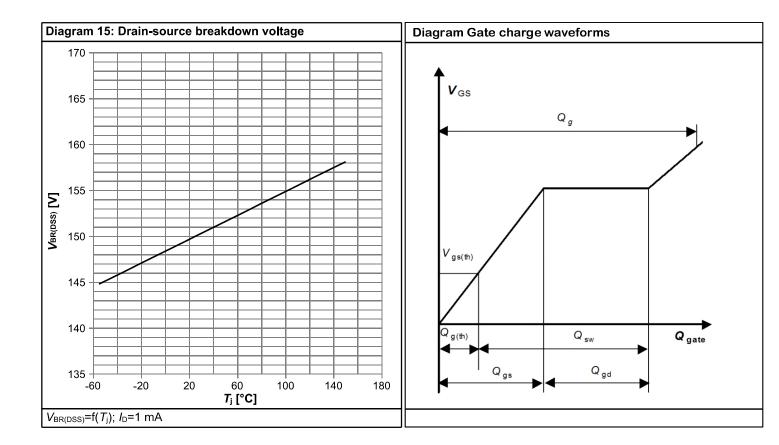






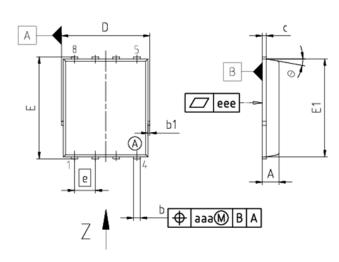


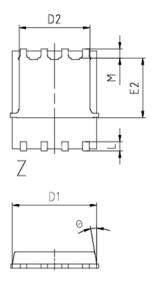






5 Package Outlines





| | MILLIM | ETERS | | | | |
|-----|--------|-------|--|--|--|--|
| DIM | MIN | MAX | | | | |
| Α | 0.90 | 1.10 | | | | |
| b | 0.31 | 0.54 | | | | |
| b1 | 0.02 | 0.22 | | | | |
| c | 0.15 | 0.35 | | | | |
| D | 5.15 | 5.49 | | | | |
| D1 | 4.95 | 5.35 | | | | |
| D2 | 3.70 | 4.40 | | | | |
| E | 5.95 | 6.35 | | | | |
| E1 | 5.70 | 6.10 | | | | |
| E2 | 3.40 | 3.80 | | | | |
| е | 1.27 | | | | | |
| N | 8 | | | | | |
| L | 0.45 | 0.71 | | | | |
| м | 0.45 | 0.75 | | | | |
| Θ | 8.5° | 12° | | | | |
| aaa | 0.1 | 25 | | | | |
| eee | 0.08 | | | | | |

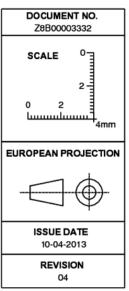


Figure 1 Outline PG-TDSON-8, dimensions in mm



Revision History

BSC110N15NS5

Revision: 2021-05-20, Rev. 2.5

| Previous Revision | | | | | | |
|-------------------|------------|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | |
| 2.0 | 2015-05-26 | Release of final version | | | | |
| 2.1 | 2015-06-09 | Update Avalanche Energy | | | | |
| 2.2 | 2017-09-18 | Update Ron max at Vgs=8V | | | | |
| 2.3 | 2018-02-21 | Update labels Diagram 9 | | | | |
| 2.4 | 2018-05-23 | Update date | | | | |
| 2.5 | 2021-05-20 | Update Diagram 11 and forward current | | | | |

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